



# **High-Power Ion Beam Deposition of Nanocomposite, Multilayer and Single-layer Metal Coatings: Synthesis and Characterization\***

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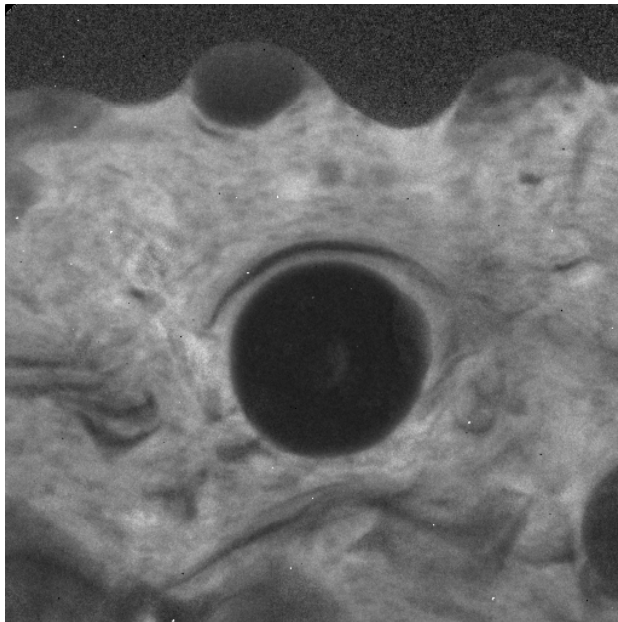
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# Outline

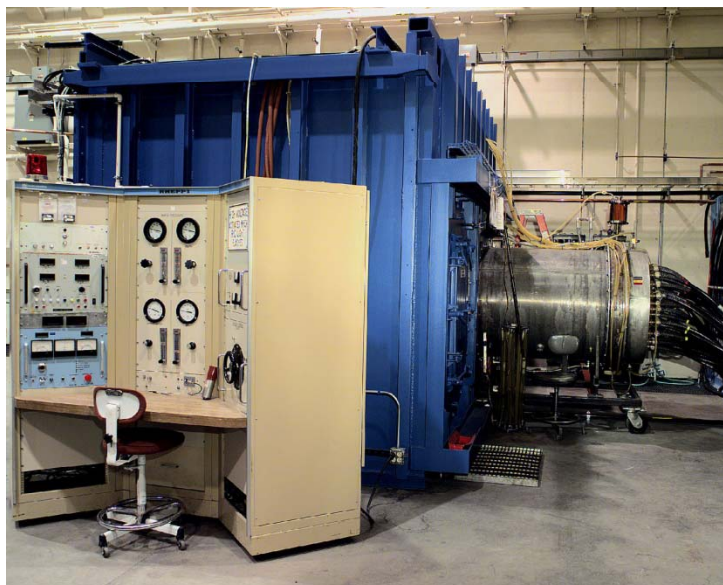
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**MoS<sub>2</sub>-Ti Nanocomposite  
Layer**

- Thin-films of multi-layer metals, nanocomposites catalyzed by sulphur (e.g. MoS<sub>2</sub>, WS<sub>2</sub>), single-metal layers
- Deposition Method: RHEPP-1 high-power ion beam
- Deposition description
- Experiment Discussion
  - MoS<sub>2</sub> with metal additions can lead to low friction/low wear in 50% RH conditions
  - Pure metal thin films: low friction, low wear IF nano-crystalline structure is maintained.
- Post Diagnostic analysis
  - Tribology – wear tracks from pin-on-disk
  - SEMs
  - FIB/XTEM
  - Spectral Imaging, XRD, SAD

## The RHEPP-1 Facility at Sandia generates intense pulsed ion beams for thin-film formation



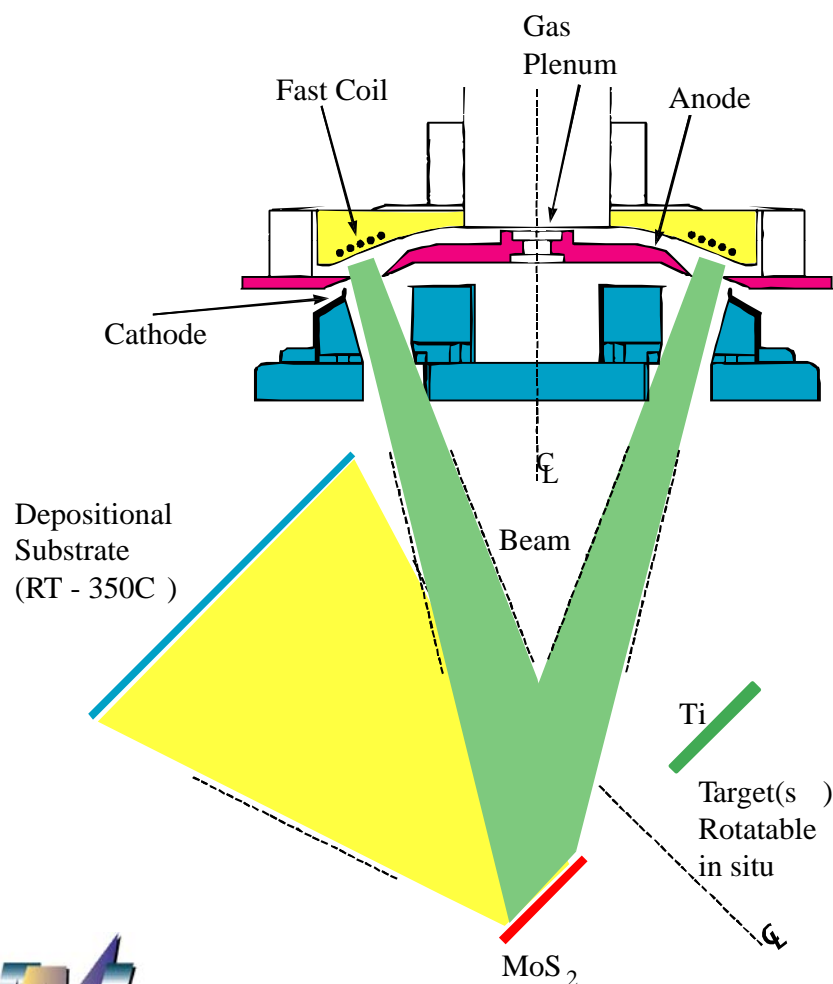
Marx tank with pulse-forming line



Vacuum tank with treatment area

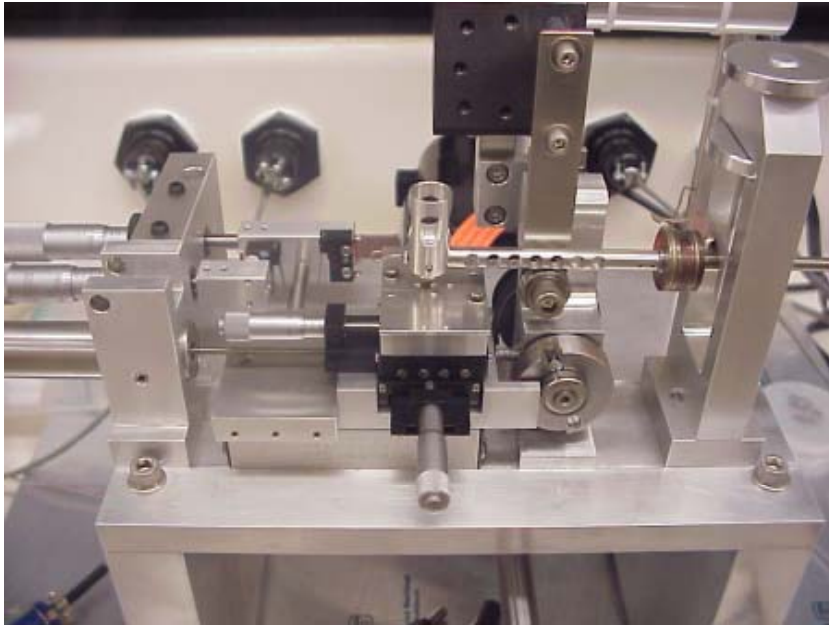
- 500-800 kV
- Up to 300 A/cm<sup>2</sup>
- Nitrogen beam used here
- Overall treatment area ~ 150 cm<sup>2</sup>
- Diode vacuum ~ 10<sup>-5</sup> Torr

## An intense ion beam is used to ablate alternating targets to form multilayer thin films

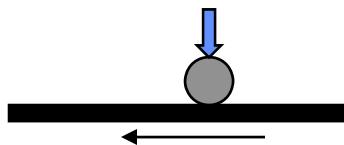


- Alternating targets (MoS<sub>2</sub> and Ti are shown) or single targets are rotated into target position for beam ablation
- Process resembles Pulsed Laser Deposition, but 50 cm<sup>2</sup> ablation spot size on target increases deposition per pulse by 2 orders of magnitude
- Nitrogen beam forms ablation plume normal to target surface. Distance target-substrate ~ 35 cm
- Film thickness/pulse from 10 to 5000 Å
- Depositional substrate heatable to 350°C

## **Tribological measurements were made in controlled environments**



**Linear Wear Tester  
(Ball-on-Flat configuration, unidirectional)**



**Counterfaces:  $\text{Si}_3\text{N}_4$  Ball (3.175 mm dia)**

**Normal Loads: 0.95 GPa (100 grams), 10 grams for most recent testing**

**Environments: Dry Nitrogen, Dry Nitrogen and Air with 50 %RH**

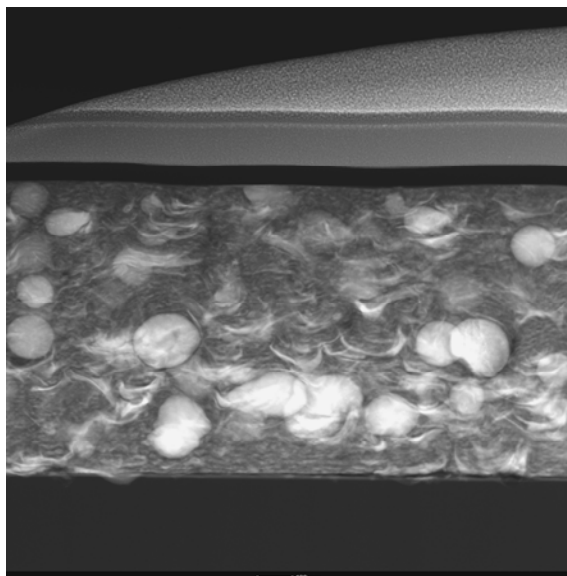


**Environmental Control**



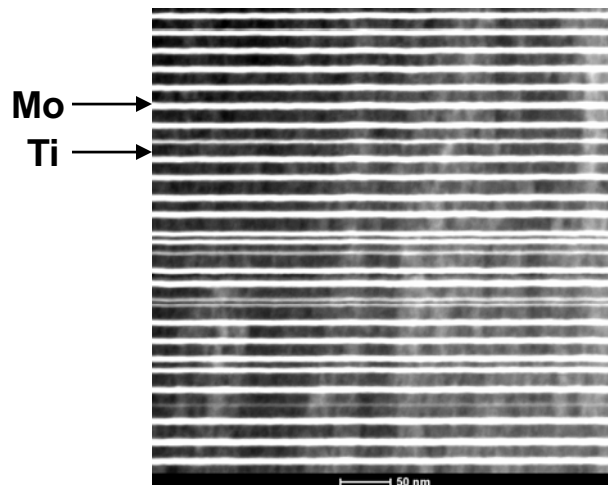
## We have formed three types of films

**MoS<sub>2</sub>-Ti multilayer  
108 Pulsed Layers**

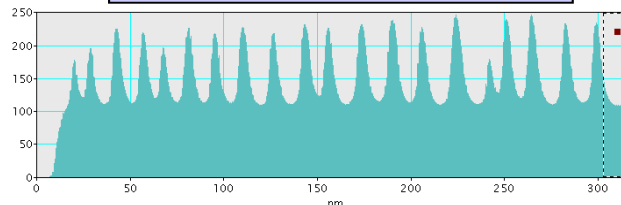


**100 nm single-crystal Mo spheres  
disrupt multi-layer structure**

**Bi-Metal layers  
(Mo-Ti, Mo-Ir, Mo-W)**

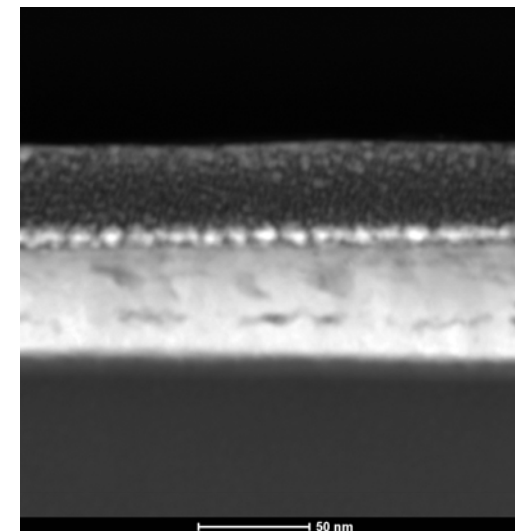


**TEM of a FIB prepared  
cross-section**



**Image contrast plot**

**Single Metal layers  
(Mo, Rh, Ni)**



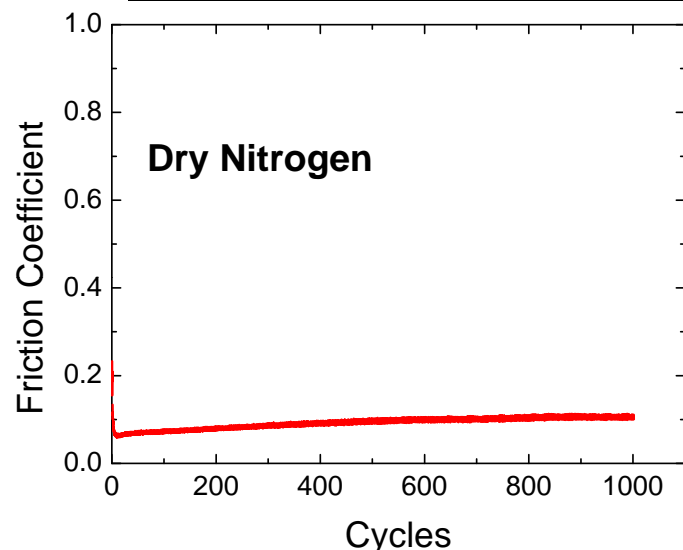
**Shown: XTEM, 50 nm pure Rh layer**

**Mo: BCC  
Rh: CCP  
Ni: CCP**

Per pulse layer thickness is controlled by:

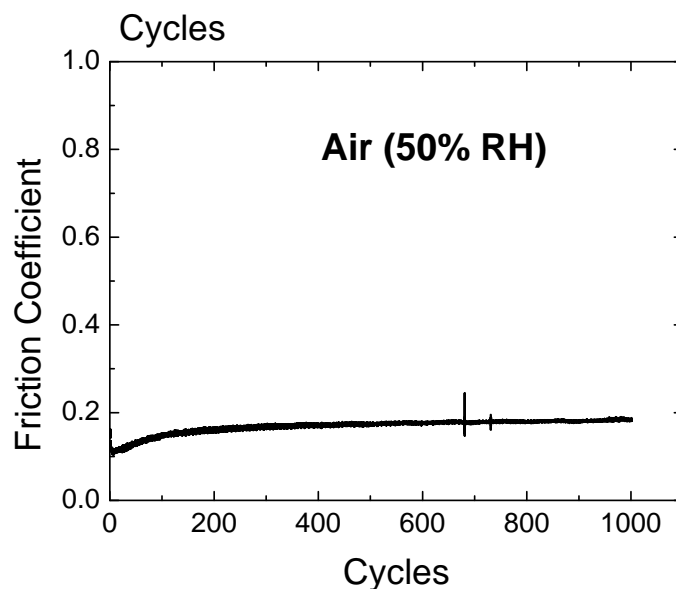
- the intrinsic ablation propensity of the material
- distance from substrate to target
- NOTE: Ti microstructure (above) continues PAST Mo interlayer

## Motivation for MoS<sub>2</sub>-Ti Film layer: low friction coefficient in 50% RH. Resulting films also have low wear

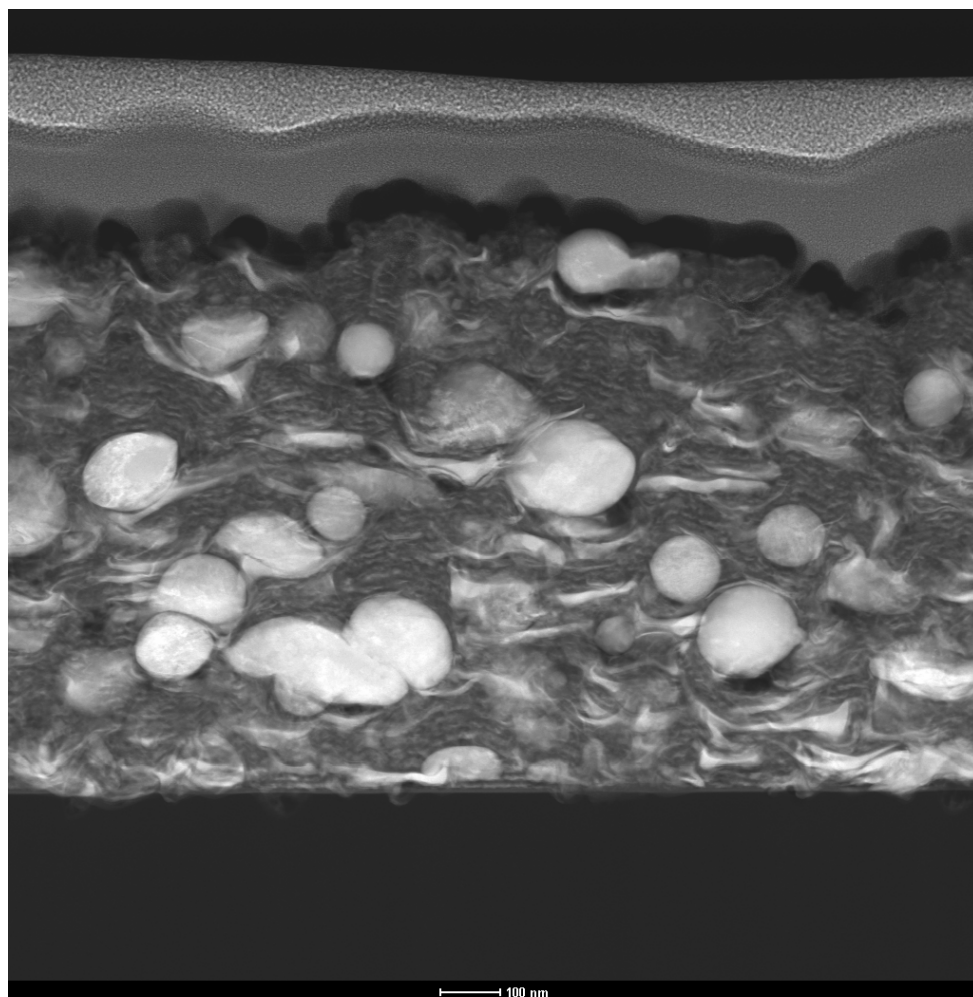


MoS<sub>2</sub>-Ti 1:2 36 cm 300°C head-on  
108 Pulsed Layers

- 1000-cycle ball-on-flat geometry in both Dry Nitrogen and Air (50% RH)
- Friction coefficient < 0.10 in Dry Nitrogen
- Slight Increase to 0.15 in 50% RH Air
- Run-in wear-through about 50 nm out of ~ 1000 nm as-deposited
- Requires 300°C in-situ substrate heating, 1:2 MoS<sub>2</sub>-Ti layer ratio.



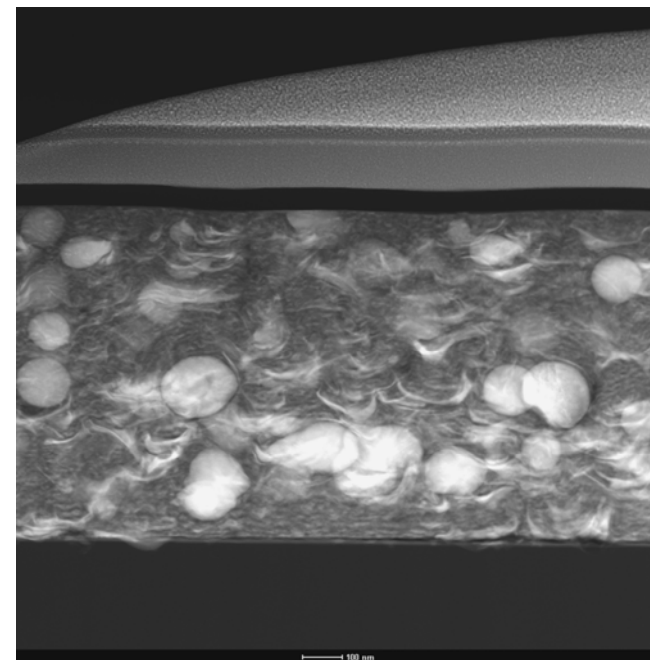
**FIB/XTEMs: (left) as deposited, (right) under wear track:  
Self-Assembled array of 100 nm Mo spheres**



C/Pt  
cover

100 nm  
Mo  
spheres

Si  
substrate

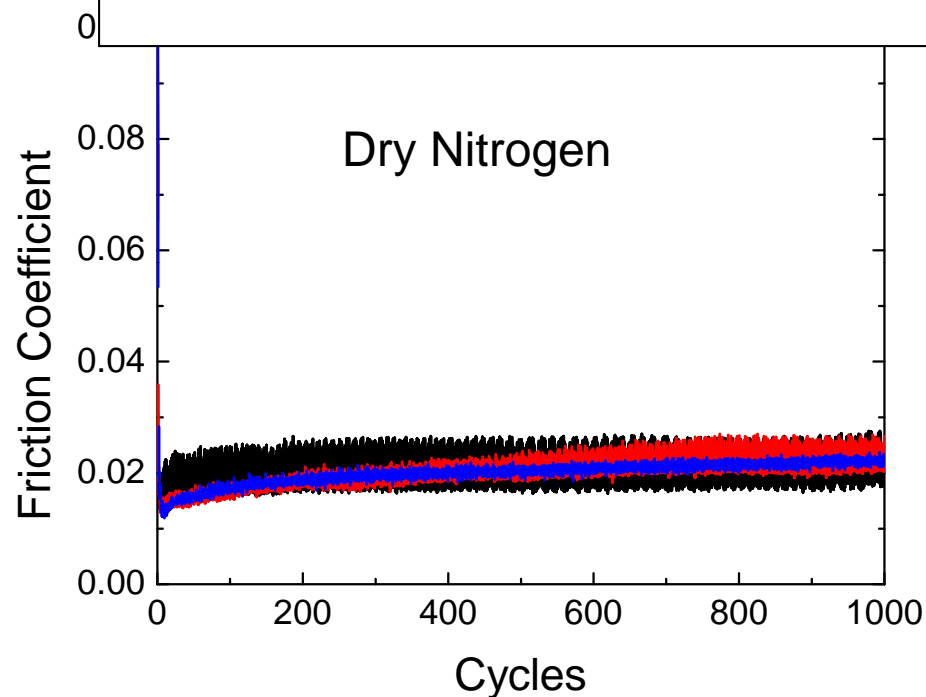


- 10 nm multi-layer (108 layers) disrupted by Mo single-crystal spheres
- Ti appears to be nano-crystalline
- Si<sub>3</sub>N<sub>4</sub> ball smooths off top roughness

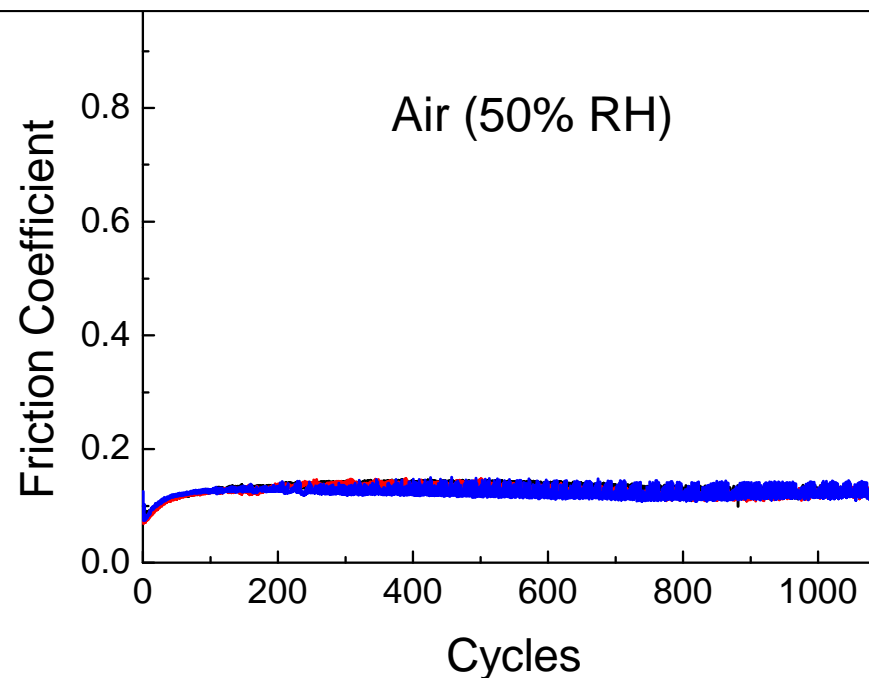
Deposition rate: MoS<sub>2</sub> ~ 30 nm/pulse, Ti ~ 7.5 nm/pulse



## Friction Behavior of $\text{MoS}_2\text{-V}$ Films better in dry and 50%RH than $\text{MoS}_2\text{-Ti}$ films



Average COF:  $0.019 \pm 0.007$

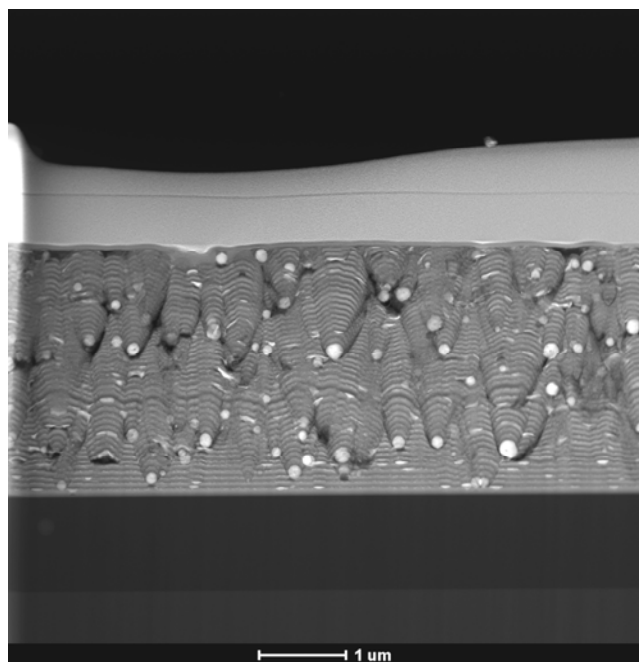


Average COF:  $0.125 \pm 0.027$

Counterface:  $\text{Si}_3\text{N}_4$  Ball  
Contact Stress: 1.1 GPa

## MoS<sub>2</sub>-V 1:2 300C

### FIB/XTEMs: Structure with V similar to Ti



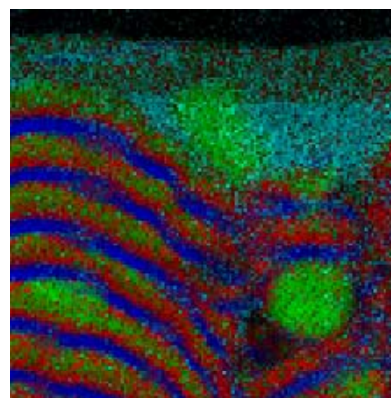
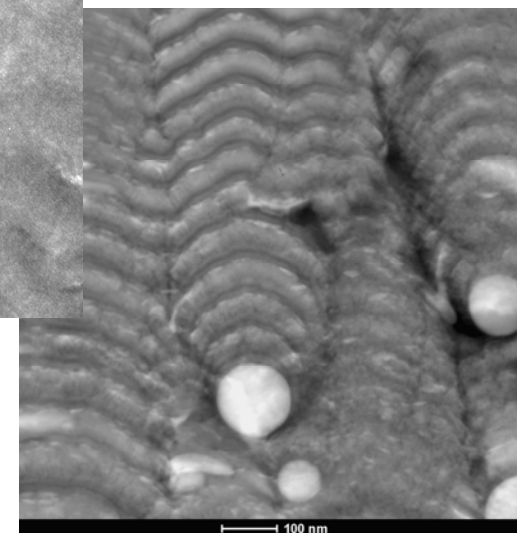
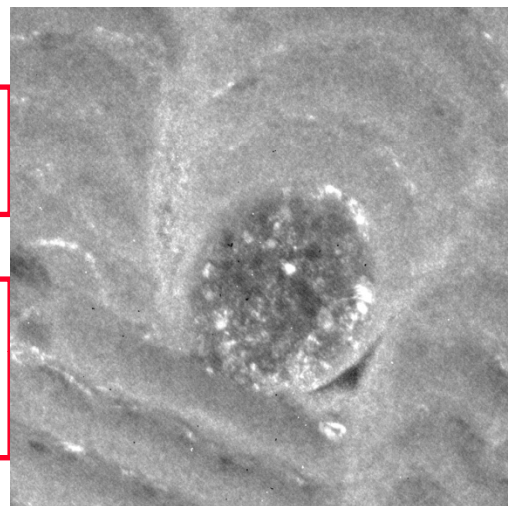
C/Pt  
cover

100 nm  
Mo  
spheres

Si  
substrate

- Similar 10 nm multi-layer (108 layers) disrupted by Mo single-crystal spheres

Composite  
Spectral  
Image



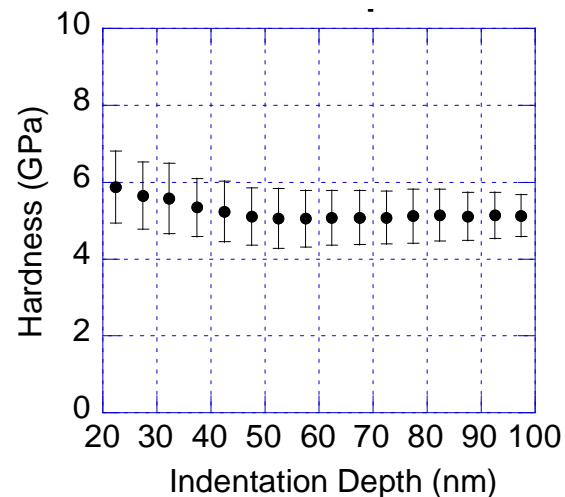
Red = Mo-S  
Green = Mo  
Blue = V  
Cyan = Mo-O

Deposition rate: MoS<sub>2</sub> ~ 300Å/pulse, Ti ~ 60Å/pulse

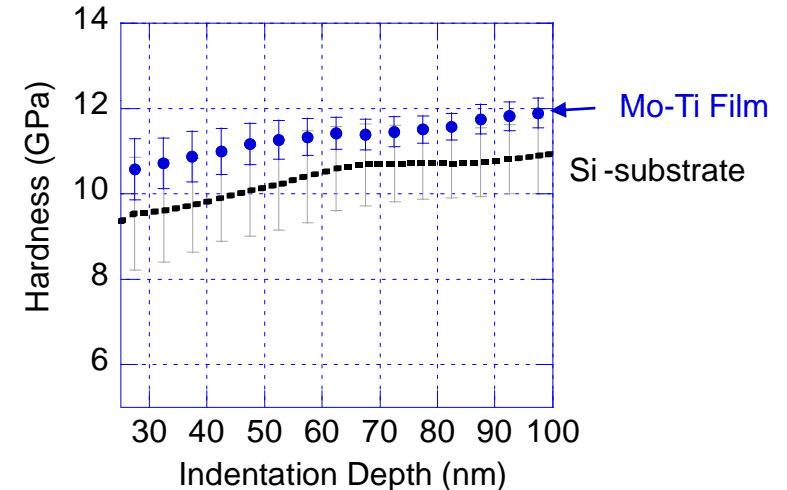


## Bi-Metal film result: Mo-Ti film exhibits an increased hardness vs. base materials

**Bulk Molybdenum Sample**



**Mo-Ti film**

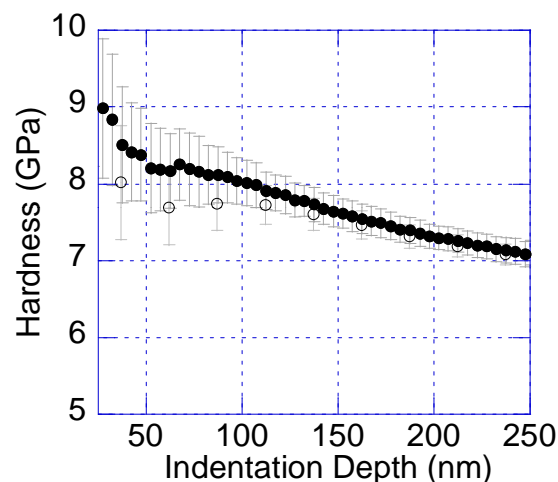


- Hardness of commercially pure Ti: 2-3 GPa
- Extremely fine microstructure contributes to high hardness in Mo-Ti film

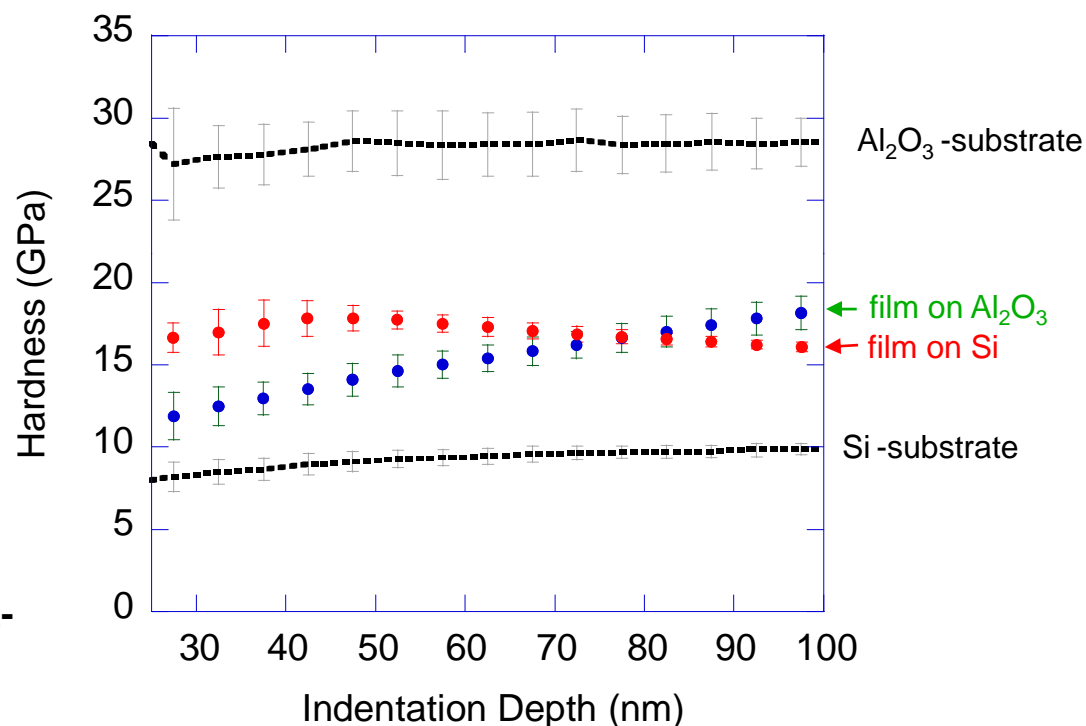
*Instrumented indentation performed with a Berkovich tip using Nanoindenter XP with CSM option*

## Mo-Ir film (big Modulus difference) exhibits a significant increased hardness vs. base materials

**Bulk Iridium Target**



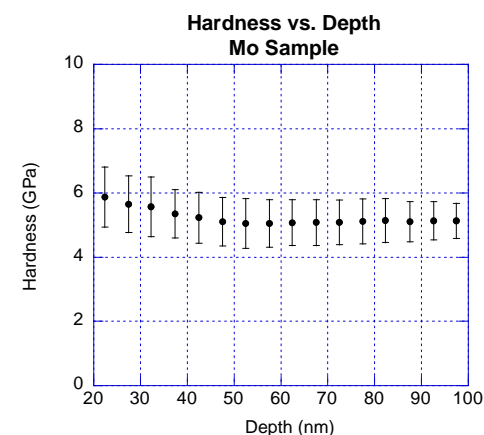
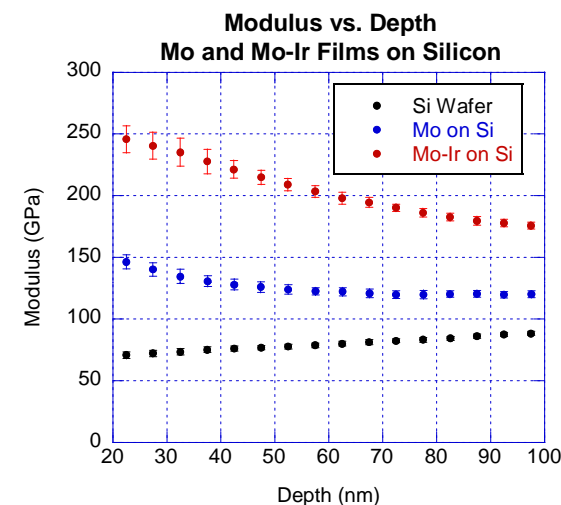
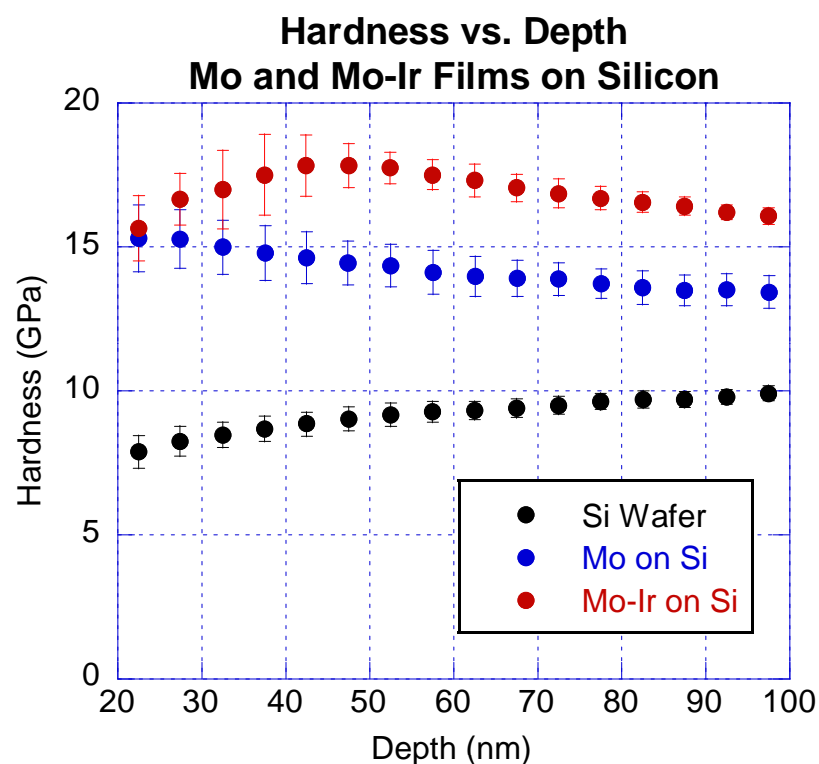
**Mo-Ir Thin-Film**



- **Mo-Ir: In-situ 315°C deposition hardest. Post-anneal *softens* film**
- **Mo-W: 560°C post-anneal *raises* multilayer hardness gain from modest to significant**
- **Films exhibit unexpected processing/properties trends**

- Mo-Ir films: significant increase in hardness vs. base materials
- Ir shows notable size scale effect

## Unexpected result: Mo only on Si substrate: surprisingly hard



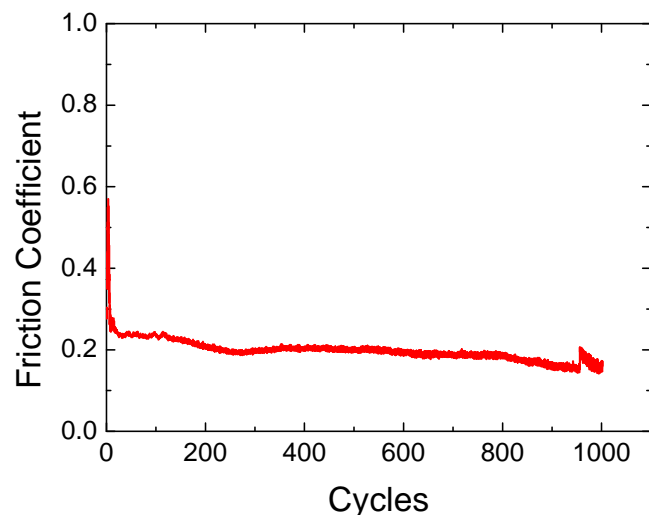
- Mo film (**BLUE Data**) is surprisingly hard, may be due to very small grain size (TEM in process)
- Mo-Ir (**RED data**) film is very hard for a metal-metal film

**Bulk Mo Target**

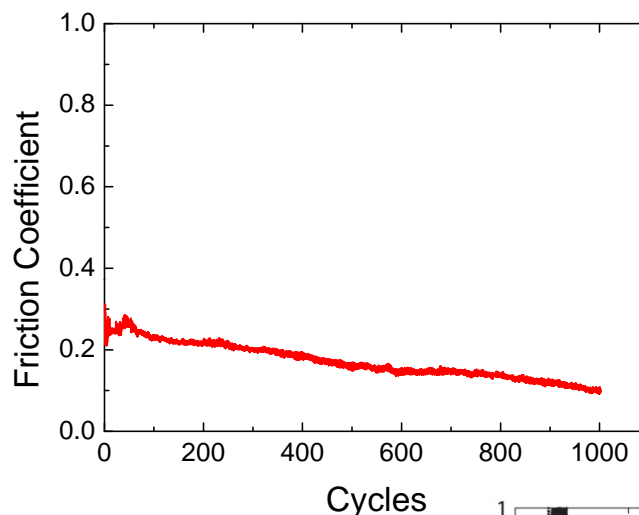


## Unexpected result: Mo thin-films from RHEPP exhibit low friction coefficient

Mo **150** nm on  $\text{Al}_2\text{O}_3$   
460°C in-situ heated

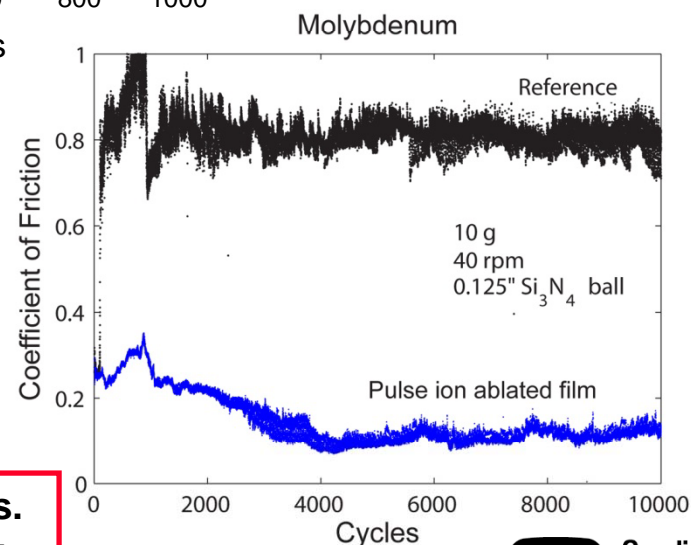


Mo **50** nm on  $\text{Al}_2\text{O}_3$   
460°C in-situ heated



Environment: Dry Nitrogen, 1/8 in diameter  $\text{Si}_3\text{N}_4$  ball,  
normal load 100 mN (Rh same)

- 600 nm Mo film shows same performance

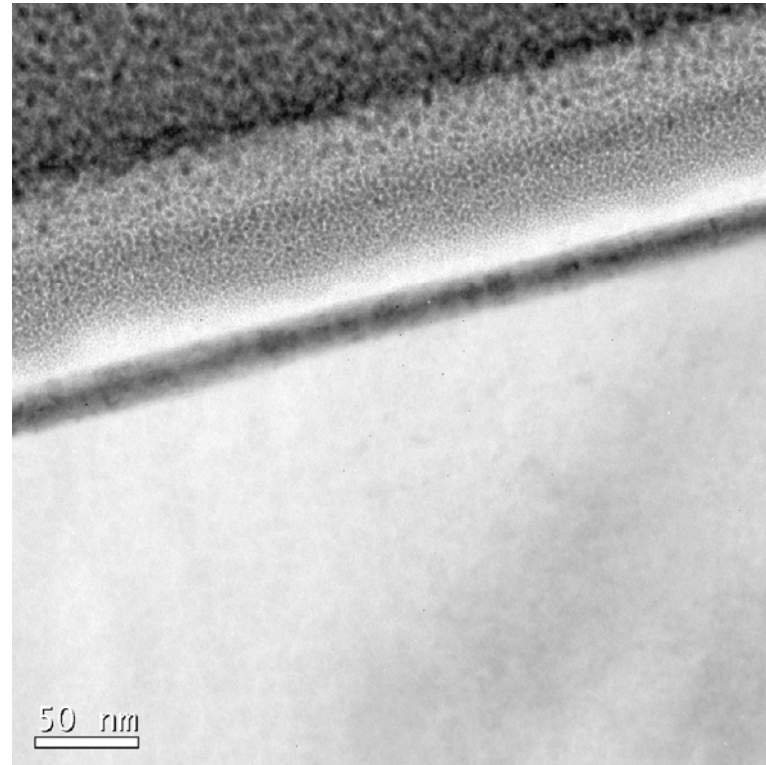


Recent test to 10,000 cycles.  
Note high 'reference' (bulk  
Mo) friction



## Suspect fine-grain Mo microstructure. Confirmed by XTEM.

Pt sample  
prep overcoat



50 nm Mo layer

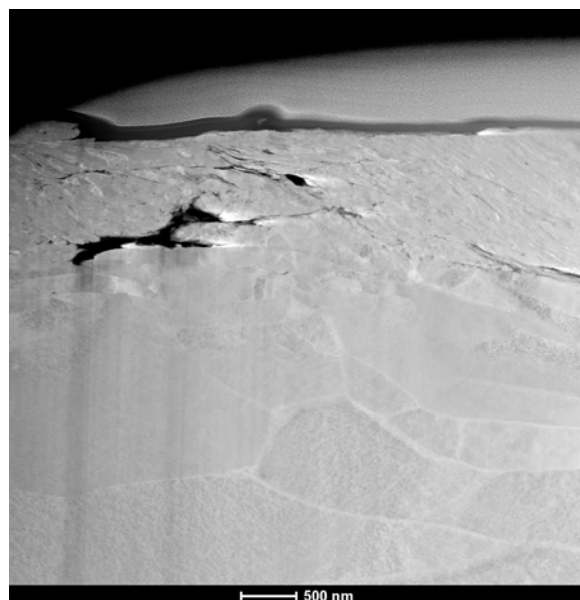
Ti adhesion layer

Al<sub>2</sub>O<sub>3</sub> substrate

- FIB cut taken under wear track from 1000 cycles

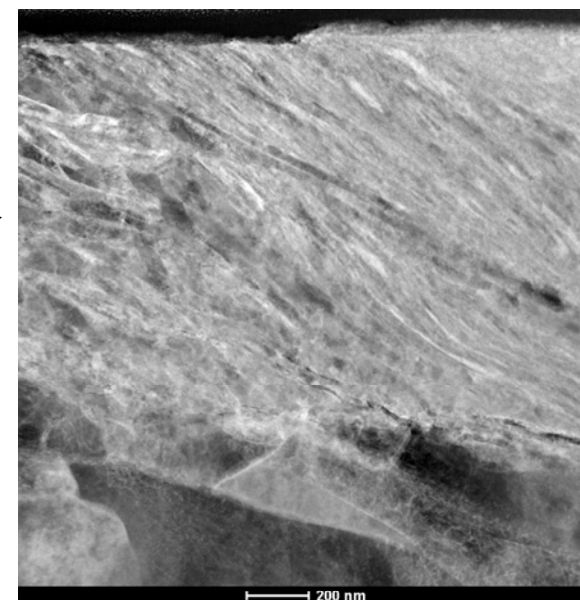
Bright-field XTEM image

## Bulk Mo target - source material for film. XTEM shows variegated grain change, mechanical shear failure



← Surface

Counterface-induced  
elongated grains

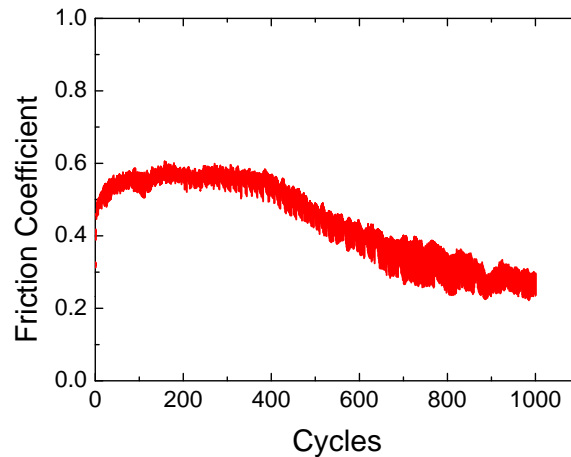


- Mechanical shear failure layer  
~ 1  $\mu\text{m}$  thick

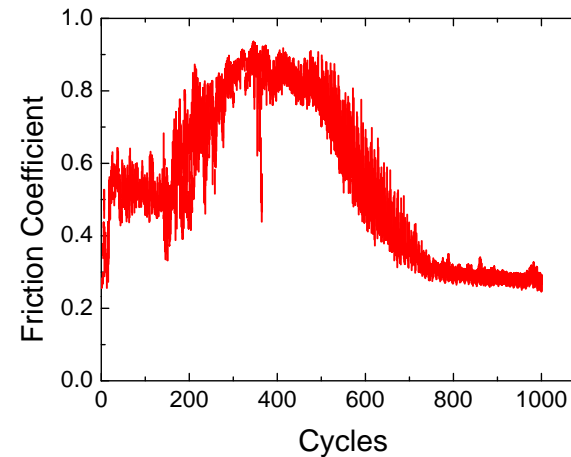




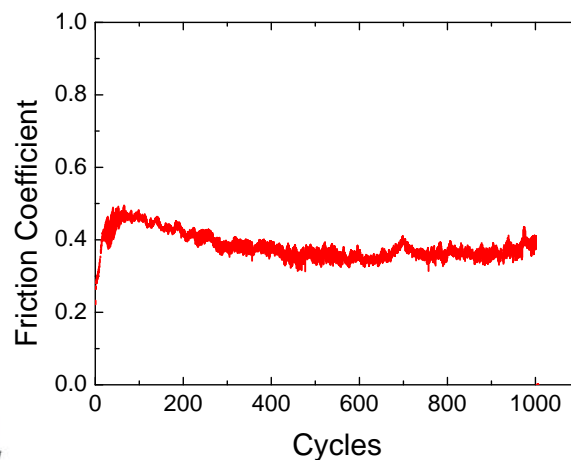
## Comparison: Pure Rh thin-films from RHEPP-1 exhibit unremarkable friction coefficient



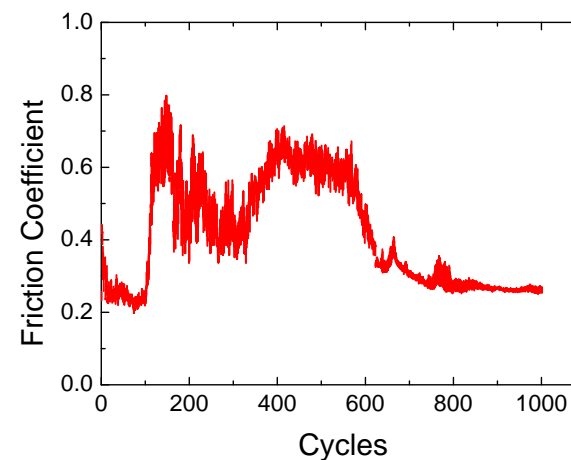
**~ 200 nm Rh 480°C**



**~ 25 nm Rh RT**

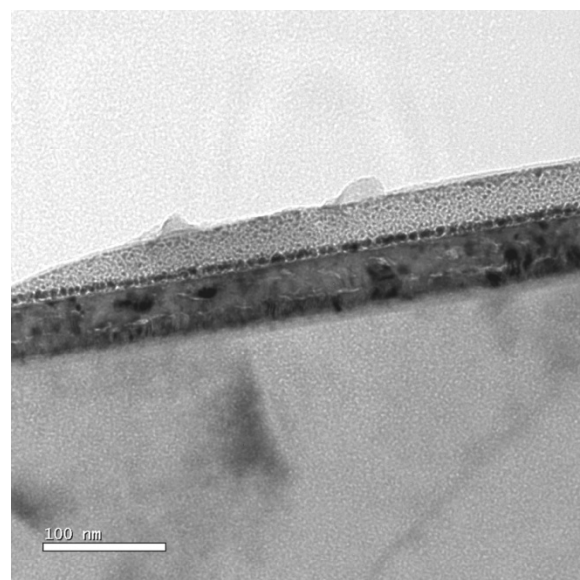


**~ 200 nm Rh RT**



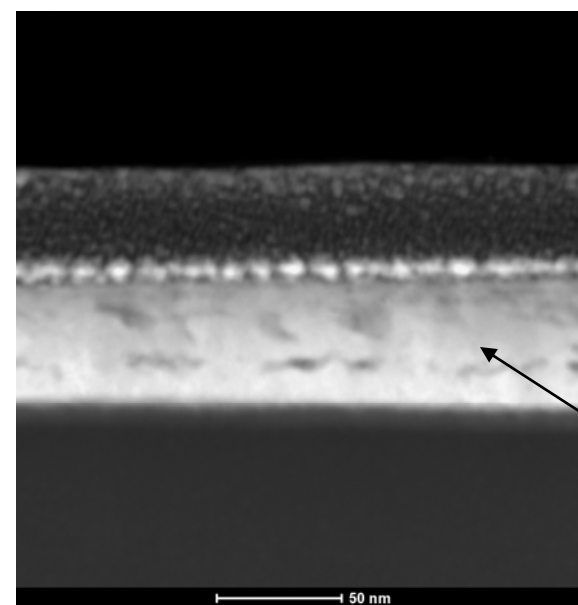
**~ 25 nm Rh 460°C**

## Rhodium film XTEMs. Porosity in layer, inhomogeneous grain growth, possible wear debris



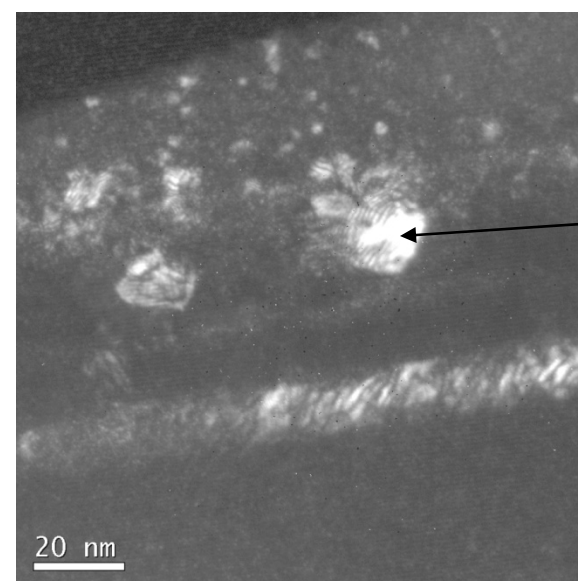
50 nm Rh layer

$\text{Al}_2\text{O}_3$  substrate



Wear Debris?

Appears not  
fully dense

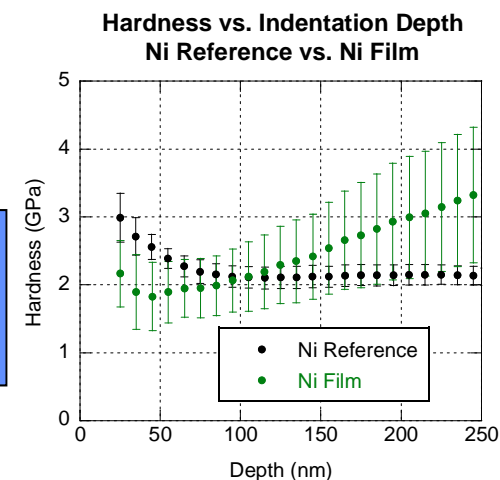
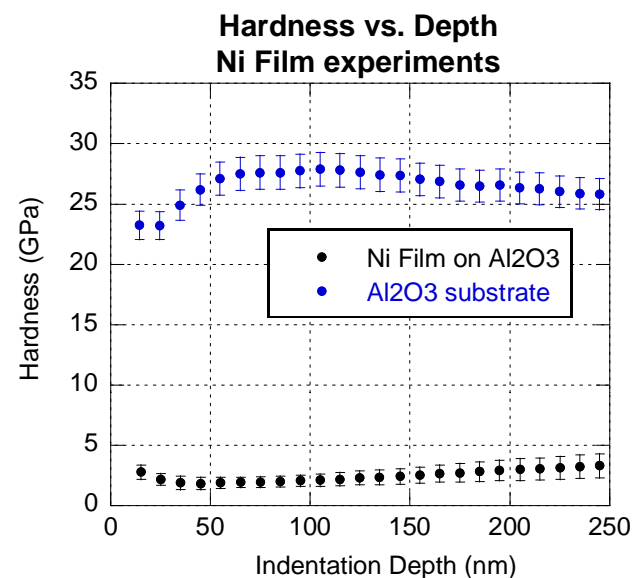
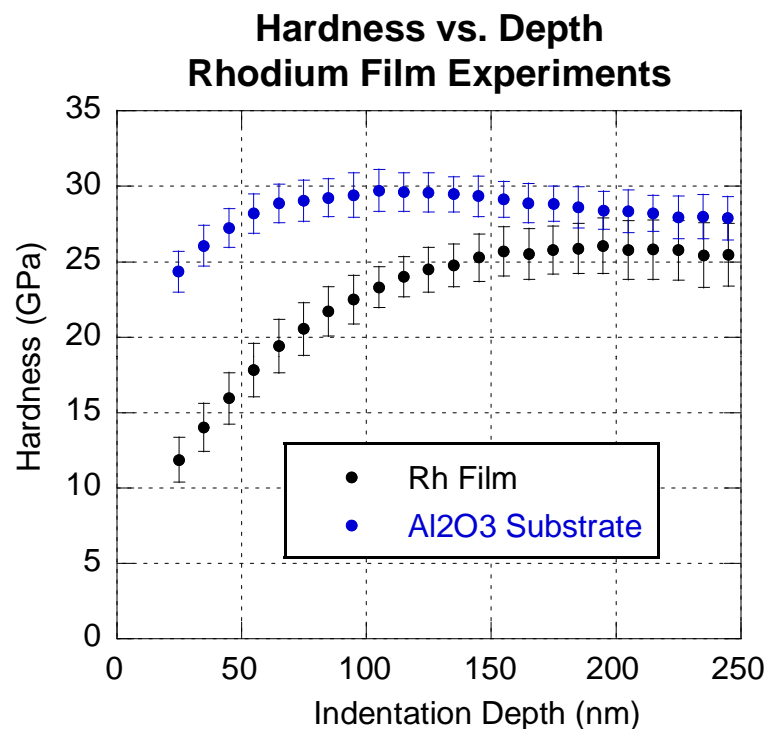


Spontaneous  
Grain growth

- FIB cut taken under wear track from 1000 cycles

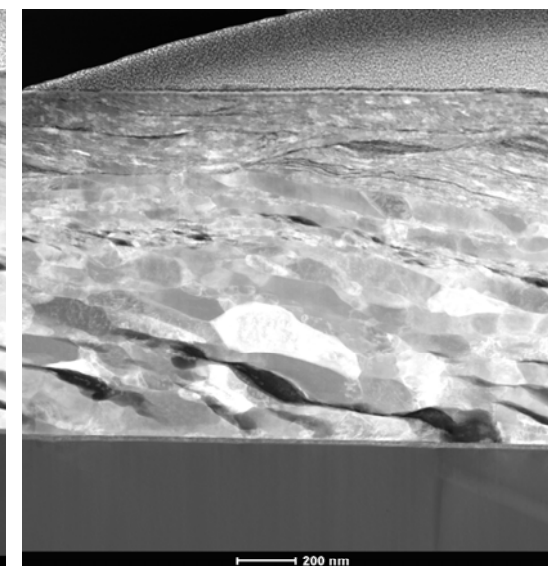
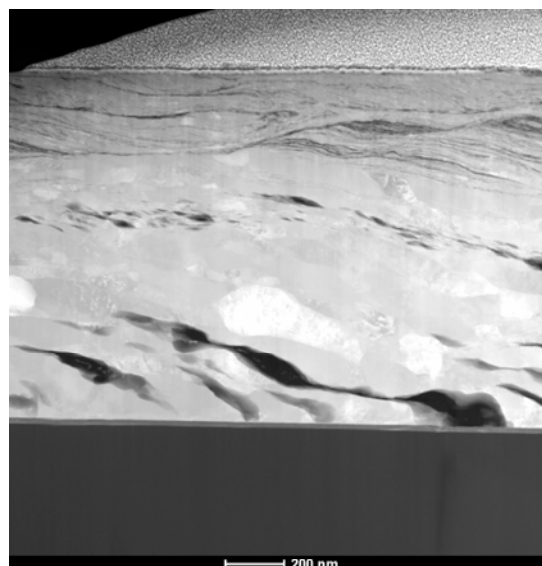
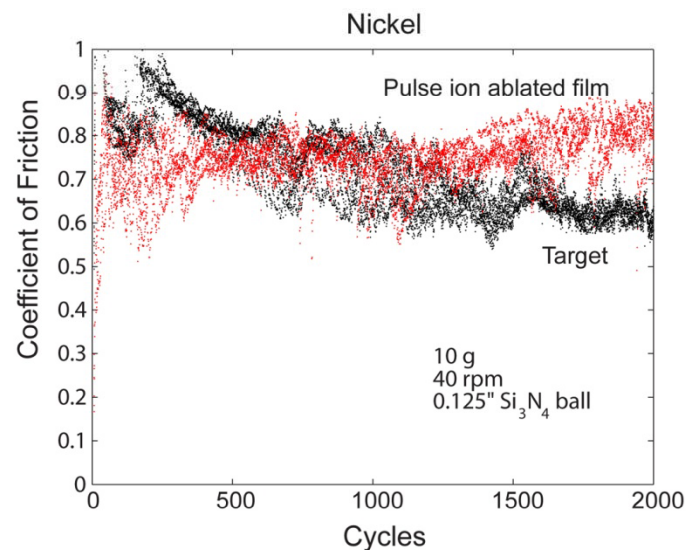


# Rhodium film hardness from nano-indentation: Not as hard as Mo film, but still 10 GPa.



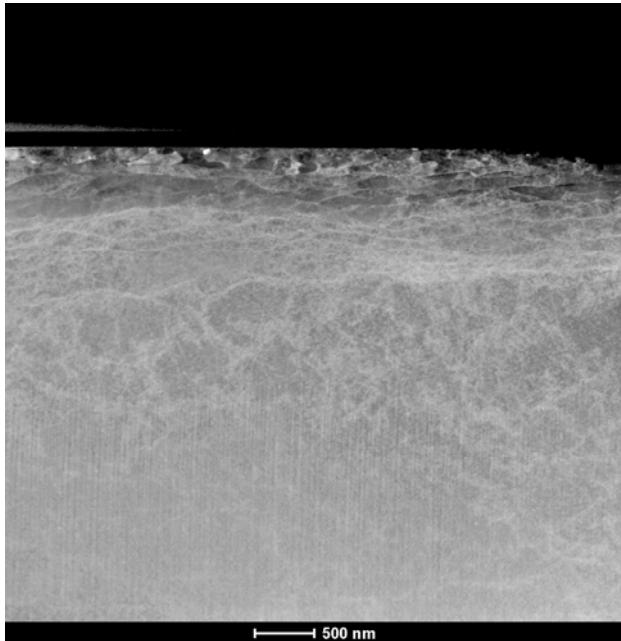
• **(RIGHT) 3rd film - Nickel. Both film and bulk target test soft (2 GPa)**

**Both Ni film and target exhibit high friction coefficient.  
XTEM shows grain size increasing towards layer bottom, 'pancake' grain  
structures, mechanical failure throughout 1  $\mu\text{m}$  thickness**

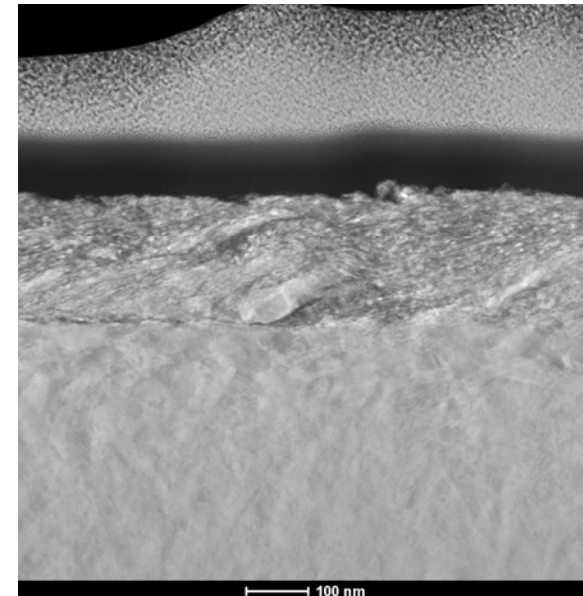


- Hypothesis: high friction due to counterface 'plowing' through soft layer

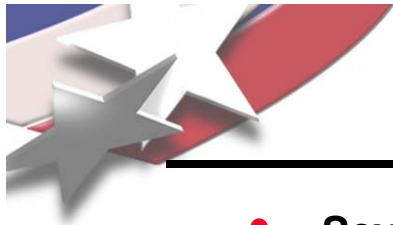
## Previous tribology experiments with Nickel suggest grain evolution is inevitable, but Fe addition may be beneficial



- Single-crystal Ni evolves pancake grains near surface under tribological testing



- Ni w/ 20at% Fe: grain evolution, but low friction. Fe may stabilize grain boundaries



# Summary

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- Several research paths discussed here: nanocomposite  $\text{MoS}_2$ -Me2 films for low wear-low friction, bi-metal hard layers, single-element metal films.
- $\text{WS}_2$ -Zr has replicated some aspects of  $\text{MoS}_2$ -X films. So Me1:S:Me2 films may form a class of self-assembled nanocomposite films with attractive properties.
- Bi-metal films: multi-layer films, hardness may be related to difference in shear modulus of two metals.
- Single metal films: nanocrystalline film microstructure (Mo) leads to hard, low-wear films with low friction coefficient. Key is keeping the grain size small. Hypothesis: Once grain enlargement reaches a critical level, layer properties deteriorate. This may be related to number of slip planes available. Fine-grain BCC material (e.g. Mo, W) has clear differences in mechanical behavior compared to large-grain material.
- Rh and Ni both CCP, but Rh is harder. Ni performance may be improved by adding Fe to stabilize grain boundaries.
- This is a Work in Progress.